

# SPECIFICATION FOR TFT MODULE

# MODULE NO:AFS128160TG-1.8-N300001 REVISION NO: 01

**Customer's Approval:** 

	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)	XJZ	2011-12-8
CHECKED BY	YHW	2011-12-8
APPROVED BY	HSH	2011-12-8

## **DOCUMENT REVISION HISTORY**

00       Nov-06-2010       First Issue       Lhm         01       Mar-20-2012       Changed "Dimensional Outline"       Fr.li	Version	DATE	DESCRIPTION	CHANGED BY
01 Mar-20-2012 Changed "Dimensional Outline" Fr.li	00	Nov-06-2010	First Issue	Lhm
	01	Mar-20-2012	Changed "Dimensional Outline"	Fr.li

## **CONTENTS**

1. Features & Mechanical specifications	1
2. Dimensional Outline	2
3. Block Diagram	3
4. Pin Description	4
5. Absolute Maximum Ratings	5
6. Electrical Characteristics	5
7. Backlight Specification	5
8. Electro-Optical Characteristics	6
9. Instruction Description	8
10. AC Characteristics	12
11. Quality Specification	15

## 1. Features & Mechanical Specifications

Item	Contents LCD	Unit
LCD Type	262K TFT / Transmissive / Normal White	
Viewing direction	12 O'clock	
Backlight	2 Chip White LED in Parallel	
Interface	8080-8bit parallel bus interface	
Driver IC	ST7735R	
Outline Dimension	$34.0(W) \times 47.0(H) \times 2.5(T)$	mm
Glass area (W×H×T)	30.432 ×37.44/40.47 × 0.5	mm
Active area (W×H)	28.032 × 35.04	mm
Number of Dots	$128(\text{RGB}) \times 160$	
Dot pitch (W×H)	0.073 × 0.219	mm
Pixel pitch (W×H)	0.219 × 0.219	mm
Operating Temperature	$-10 \sim +70$	°C
Storage temperature	$-30 \sim +80$	°C

## **2. Dimensional Outline**

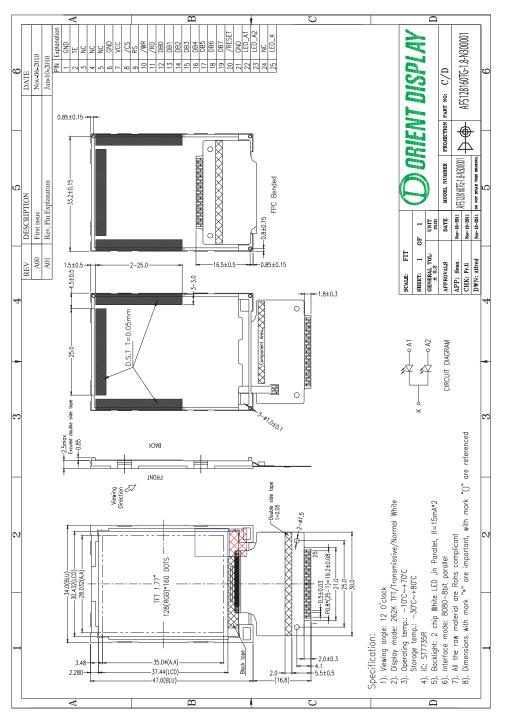


Figure 1. Dimensional outline

## 3. Block Diagram

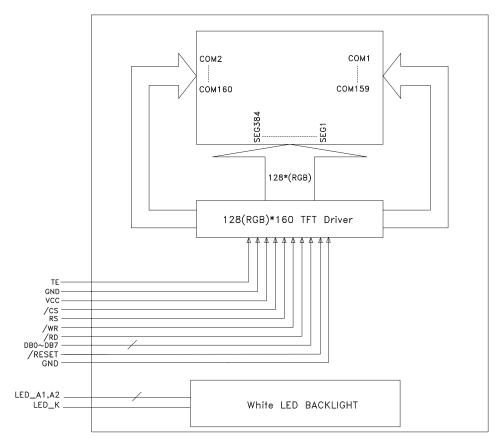


Figure 2. Block diagram

## 4. Pin Description

PIN No.	SYMBOL	Function
1	GND	Ground
2	TE	Tearing effect output pin
3~5	NC	No Connection
6	GND	Ground
7	VCC	Power supply
8	/CS	Chip Select Signal ( Active Low)
9	RS	The signal for register index or register command select Low: Register index or internal status (in read operation) High: Register command.
10	/WR	Write signal.
11	/RD	Read signal.
12~19	DB0~DB7	Data Bus
20	/RESET	Reset pin. (Active Low)
21	GND	Ground
22	LED_A1	Backlight LED1 Anode
23	LED_A2	Backlight LED2 Anode
24	NC	No Connection
25	LED_K	Backlight LED Cathode

## **5. Absolute Maximum Ratings**

Item	Symbol	Rating	Unit
Supply Voltage range	VCC	-0.3 to +4.6	V
Operating Temperature range	TOP	-10 to +70	°C
Storage Temperature range	TST	-30 to +80	°C

## **<u>6. Electrical Characteristics</u>**

### **DC Characteristics**

Item	Symbol	Min.	Type.	Max.	Unit
Logic Supply Voltage	VCC	2.6	2.75	3.3	V

## 7. Backlight Characteristics

White	LED	Х	2
** IIIte	LLD	<pre>/ ``</pre>	4

while LED $\wedge 2$						(1a - 23C)
Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	VF	IF = 30mA	-	3.2	-	V
Uniformity	∆Bp	-	80	-	-	%
Luminance for LCD	Lv	IF = 30mA	3000	3500	4000	cd/m <sup>2</sup>

 $(Ta = 25^{\circ}C)$ 

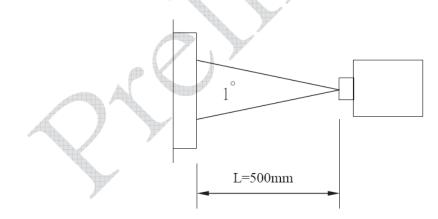
## **8. Electro-Optical Characteristics**

(Note1 , Note2)

(Using CPT LC+ Normal Polarizer+Corresponding Backlight, reference only)

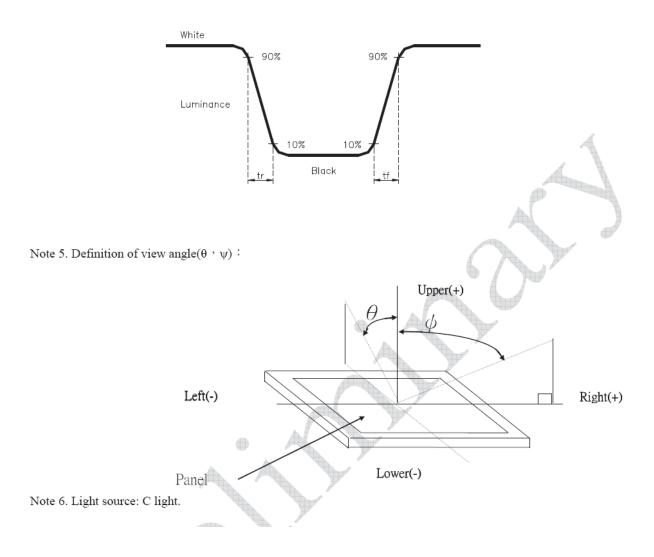
ITEM	I	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK	
Transmit	Transmittance			(6.4)	(6.9)		%		
Contrast Ratio		CR	*1)		(250)	-		Note 3	
Response Time		Tr+ Tf	*3)	-	(30)		ms	Note 4	
	Vertical	θ*2)	(55)	(60)	-			Note 5	
Viewing Angle	Horizontal	ψ*2)	(85)	(90)	-		4		
		х	(0.288)	(0.308)	(0.328)				
	White	У	(0.321)	(0.341)	(0.361)	-			
		Ŷ	(29.2)	(32.2)	(35.2)				
		х	(0.635)	(0.655)	(0.675)				
	Red	У	(0.312)	(0.332)	(0.352)			1	
		Υ	(15.2)	(18.2)	(21.2)		1	1	
Color Filter		х	(0.294)	(0.314)	(0.334)			Note 6	
Chromacicity	Green	У	(0.554)	(0.574)	(0.594)			Note o	
		Υ	(59.2)	(62.2)	(65.2)	1		]	
		х	(0.117)	(0.137)	(0.157)	r		]	
	Blue	У	(0.115)	(0.135)	(0.155)				
		Y	(13.1)	(16.1)	(19.1)			]	
	NTSC		-	(58%)	-				

Note 1. Ambient condition : 25°C ±2°C <br/>, 60±10%RH , under 10 Lunx in the darkroom  $\circ$  Note 2.<br/>Measure device : BM-5A (TOPCON) , viewing cone= 1 ° , IL=20<br/>mA  $\circ$ 



Note 3. Definition of Contrast Ratio : CR = White Luminance (ON) / Black Luminance (OFF)

Note 4. Definition of response time : The response time is defined as the time interval between the 10% and amplitudes.



## 9. Instruction Description

Instruction	Refer				D23-8	,	D6	D5	D4	D3	D2	D1	D0	Hex	Function
		0	ſ	1	-	1	0	1	1	0	0	0	1	(B1h)	In normal mode (Full colors)
FRMCTR1	10.2.1	1	î	1	-					RTNA3	RTNA2	RTNA1	RTNA0		RTNA set 1-line
		1	î	1	-			FPA5	FPA4	FPA3	FPA2	FPA1	FPA0		period FPA: front porch
		1	1	1	-			BPA5	BPA4	BPA3	BPA2	BPA1	BPA0		BPA: back porch
		0	Î	1	-	1	0	1	1	0	0	1	0	(B2h)	In Idle mode (8-colors)
FRMCTR2	10.2.2	1	Î	1	-					RTNB3	RTNB2	RTNB1	RTNB0		RTNB: set 1-line
		1	î	1	-			FPB5	FPB4	FPB3	FPB2	FPB1	FPB0		period FPB: front porch
		1	î	1	-			BPB5	BPB4	BPB3	BPB2	BPB1	BPB0		BPB: back porch
		0	Ŷ	1	-	1	0	1	1	0	0	1	1	(B3h)	In partial mode + Full colors
		1	î	1	-					RTNC3	RTNC2	RTNC1	RTNC0		
		1	î	1	-			FPC5	FPC4	FPC3	FPC2	FPC1	FPC0		RTNC,RTND: set
FRMCTR3	10.2.3	1	î	1	-			BPC5	BPC4	BPC3	BPC2	BPC1	BPC0		1-line period FPC,FPD: front
		1	î	1	-					RTND3	RTND2	RTND1	RTND0		porch
		1	î	1	-			FPD5	FPD4	FPD3	FPD2	FPD1	FPD0		BPC,BPD: back porch
		1	î	1	-			BPD5	BPD4	BPD3	BPD2	BPD1	BPD0		
INVCTR	10.2.4	0	ſ	1	-	1	0	1	1	0	1	0	0	(B4h)	Display inversion control
INVOIR	10.2.4	1	î	1	-	0	0	0	0	0	NLA	NLB	NLC		NLA,NLB,NLC set inversion
		0	¢	1	-	1	0	1	1	0	1	1	0	(B6h)	Display function setting
DISSET5	10.2.5	1	¢	1	-	1	0	NO1	NO0	SDT1	SDT0	EQ1	EQ0		SDT: set amount of source delay EQ: set EQ period
		1	Ŷ	1	-	1	1	1	1	PTG1	PTG0	PT1	PT0		

Panel Function Command List (1)

Instruction	Refer	D/CX	WRX	RDX	D17-8	D7	D6	D5	D4	D3	D2	D1	D0	Hex	Function
		0	Î	1	-	1	1	0	0	0	0	0	0	(C0h)	Power control setting
		1	Ť	1	-	AVDD[ 2]	AVDD[ 1]	AVDD [0]	VRHP 4	VRHP 3	VRHP 2	VRHP 1	VRHP 0		
PWCTR1	10.2.5	1	Ť	1	-	0	0	0	VRHN 4	VRHN 3	VRHN 2	VRHN 1	VRHN 0		VRH: Set the GVDD voltage
		1	t	1		MODE [1]	MODE [0]	0	0	0	1	0	0		
		0	1	1	-	1	1	0	0	0	0	0	1	(C1h)	Power control setting
PWCTR2	10.2.7	1	Î	1	-	VGH2 5[1]	VGH2 5[0]	-	-	VGLSEL [1]	VGLSEL [0]	VGHBT[ 1]	VGHBT[ 0]		BT: set VGH/ VGL voltage
		0	t	1	-	1	1	0	0	0	0	1	0	(C2h)	In normal mode (Full colors)
PWCTR3	10.2.8	1	1	1	-	DCA9	DCA8	SAPA 2	SAPA 1	SAPA 0	APA2	APA1	APA0		APA: adjust the operational amplifier
					-	DCA7	DCA6	DCA5	DCA4	DCA3	DCA2	DCA1	DCA0		DCA: adjust the booster Voltage
		0	1	1	-	1	1	0	0	0	0	1	1	(C3h)	In Idle mode (8-colors)
PWCTR4	10.2.9	1	î	1	-	DCB9	DCB8	SAPB 2	SAPB 1	SAPB 0	APB2	APB1	APB0		APB: adjust the operational amplifier DCB: adjust the booster
					-	DCB7	DCB6	DCB5	DCB4	DCB3	DCB2	DCB1	DCB0		Voltage
		0	Ť	1	-	1	1	0	0	0	1	0	0	(C4h)	In partial mode + Full
PWCTR5	10.2.10	1	1	1	-	DCC9	DCC8	SAPC 2	SAPC 1	SAPC 0	APC2	APC1	APC0		APC: adjust the operational amplifier
		1	ſ	1	-	DCC7	DCC6	DCC5	DCC4	DCC3	DCC2	DCC1	DCC0		DCC: adjust the booster circuit for Idle mode
VMCTR1	10.2.11	0	î	1	-	1	1	0	0	0	1	0	1	(C5h)	VCOM control 1
VINCIRI	10.2.11	1	î	1	-	-	-	VCOMS 5	VCOMS	VCOMS 3	VCOMS 2	VCOMS 1	VCOMS 0		VCOM voltage control
		0	Ŷ	1	-	1	1	0	0	0	1	1	1	(C7h)	Set VCOM offset control
VMOFCTR	10.2.12	1	î	1	-	-	-	-	VMF4	VMF3	VMF2	VMF1	VMF0		
		0	1	1	-	1	1	0	1	0	0	0	1	(D1h)	Set LCM version code
WRID2	10.2.13	1	Ť	1	-	-	ID2[6]	ID2[5]	ID2[4]	ID2[3]	ID2[2]	ID2[1]	ID2[0]		

Panel Function Command List (2)

"-": Don't care

Note 1: C0h to C7h are fixed for about power controller

Instruction	Refer	D/CX	WRX	RDX	D17-8	D7	D6	D5	D4	D3	D2	D1	D0	Hex	Function							
																				Customer Project		
MDD2	10.2.14	0	Î	1	-	1	1	0	1	0	0	1	0	(D2h)	code							
WRID3	10.2.14														Set the project code							
		1	Î	1	-	ID37	ID36	ID35	ID34	ID33	ID32	ID31	ID30		at ID3							
		0	Î	1	-	1	1	0	1	1	0	0	1	(D9)								
NVCTR1	NVCTR1 10.2.15	1	î	1	-	0	VMF _EN	ID2 _EN	0	0	0	0	EXT_ R		NVM control status							
		0	î	1	-	1	1	0	1	1	1	1	0	(DEh)	NVM Read Command							
NVCTR2	10.2.16	1	î	1	-	1	1	1	1	0	1	0	1	F5								
		1	Ŷ	1	-	1	0	1	0	0	1	0	1	A5	Action code							
NVCTR3 10.2.									0	↑	1	-	1	1	0	1	1	1	1	1	(DFh)	NVM Write Command
	10.2.17	1	↑	1	-	NVM_	_	_			_											
"-": Don't		1	, ↑	1	-	CMD7 1	CMD6 0	CMD5 1	CMD4 0	CMD3 0	CMD2 1	CMD1 0	CMD0 1		Action code							

## Panel Function Command List (3)

"-": Don't care

Note 1: The D1h to D3h registers are fixed for about ID code setting.

Note 2: The D9h, DEh and DFh registers are used for NV Memory function controller. (Ex: write, clear, etc.)

Instruction	Refer	D/CX	WRX	RDX	D17-8	D7	D6	D5	D4	D3	D2	D1	D0	Hex	Function
		0	î	1	-	1	1	1	0	0	0	0	0	(E0h)	Set
		1	î	1	-			VRFP[5]	VRFP[4]	VRFP[3]	VRFP[2]	VRFP[1]	VRF0P[0]		Gamma
		1	î	1	-			VOS0P[5]	VOS0P[4]	VOS0P[3]	VOS0P[2]	VOS0P[1]	VOS0P[0]		adjustment
		1	Î	1	-			PKP0[5]	PKP0[4]	PKP0[3]	PKP0[2]	PKP0[1]	PKP0[0]	1	(+ polarity)
		1	î	1	-			PKP1[5]	PKP1[4]	PKP1[3]	PKP1[2]	PKP1[1]	PKP1[0]		
		1	î	1	-			PKP2[5]	PKP2[4]	PKP2[3]	PKP2[2]	PKP2[1]	PKP2[0]		
		1	Î	1	-			PKP3[5]	PKP3[4]	PKP3[3]	PKP3[2]	PKP3[1]	PKP3[0]		
		1	Î	1	-			PKP4[5]	PKP4[4]	PKP4[3]	PKP4[2]	PKP4[1]	PKP4[0]		
GAMCTRP1	10.2.18	1	Î	1	-			PKP5[5]	PKP5[4]	PKP5[3]	PKP5[2]	PKP5[1]	PKP5[0]		
		1	Î	1	-			PKP6[5]	PKP6[4]	PKP6[3]	PKP6[2]	PKP6[1]	PKP6[0]		
		1	î	1	-			PKP7[5]	PKP7[4]	PKP7[3]	PKP7[2]	PKP7[1]	PKP7[0]		
		1	î	1	-			PKP8[5]	PKP8[4]	PKP8[3]	PKP8[2]	PKP8[1]	PKP8[0]		
		1	Ť	1				PKP9[5]	PKP9[4]	PKP9[3]	PKP9[2]	PKP9[1]	PKP9[0]		
		1	î	1	-			SELV0P[5]	SELV0P[4]	SELV0P[3]	SELV0P[2]	SELV0P[1]	SELV0P[0]		
		1	î	1	-			SELV1P[5]	SELV1P[4]	SELV1P[3]	SELV1P[2]	SELV1P[1]	SELV1P[0]		
		1	î	1				SELV62P[5]	SELV62P[4]	SELV62P[3]	SELV62P[2]	SELV62P[1]	SELV62P[0]		
		1	î	1	-			SELV63P[5]	SELV63P[4]	SELV63P[3]	SELV63P[2]	SELV63P[1]	SELV63P[0]		
		0	î	1	-	1	1	1	0	0	0	0	1	(E1h)	Set
		1	Î	1	-	-		VRF0N[5]	VRF0N[4]	VRF0N[3]	VRF0N[2]	VRF0N[1]	VRF0N[0]		Gamma
		1	Î	1	-			VOS0N[5]	VOS0N[4]	VOS0N[3]	VOS0N[2]	VOS0N[1]	VOS0N[0]		adjustment
		1	î	1	-			PKN0[5]	PKN0[4]	PKN0[3]	PKN0[2]	PKN0[1]	PKN0[0]		(- polarity)
		1	î	1	-			PKN1[5]	PKN1[4]	PKN1[3]	PKN1[2]	PKN1[1]	PKN1[0]		
		1	î	1	-			PKN2[5]	PKN2[4]	PKN2[3]	PKN2[2]	PKN2[1]	PKN2[0]		
		1	î	1	-			PKN3[5]	PKN3[4]	PKN3[3]	PKN3[2]	PKN3[1]	PKN3[0]		
		1	î	1	-			PKN4[5]	PKN4[4]	PKN4[3]	PKN4[2]	PKN4[1]	PKN4[0]		
GAMCTRN1	10.2.19	1	î	1	-			PKN5[5]	PKN5[4]	PKN5[3]	PKN5[2]	PKN5[1]	PKN5[0]		
		1	î	1	-			PKN6[5]	PKN6[4]	PKN6[3]	PKN6[2]	PKN6[1]	PKN6[0]		
		1	1	1	-			PKN7[5]	PKN7[4]	PKN7[3]	PKN7[2]	PKN7[1]	PKN7[0]		
		1	î	1	-			PKN8[5]	PKN8[4]	PKN8[3]	PKN8[2]	PKN8[1]	PKN8[0]		
		1	î	1	-			PKN9[5]	PKN9[4]	PKN9[3]	PKN9[2]	PKN9[1]	PKN9[0]		
		1	Î	1	-			SELVON[5]	SELVON[4]	SELVON[3]	SELVON[2]	SELVON[1]	SELVON[0]		
		1	î	1	-			SELV1N[5]	SELV1N[4]	SELV1N[3]	SELV1N[2]	SELV1N[1]	SELV1N[0]		
		1	î	1	-			SELV62N[5]	SELV62N[4]	SELV62N[3]	SELV62N[2]	SELV62N[1]	SELV62N[0]		
		1	î	1	-			SELV63N[5]	SELV63N[4]	SELV63N[3]	SELV63N[2]	SELV63N[1]	SELV63N[0]		

Panel Function Command List (4)

"-": Don't care

Note 1: E0-E1 registers are fixed for adjusting Gamma

**10. AC Characteristics** Parallel interface characteristics: 18, 16, 9 or 8-bit bus (8080 series MCU interface)

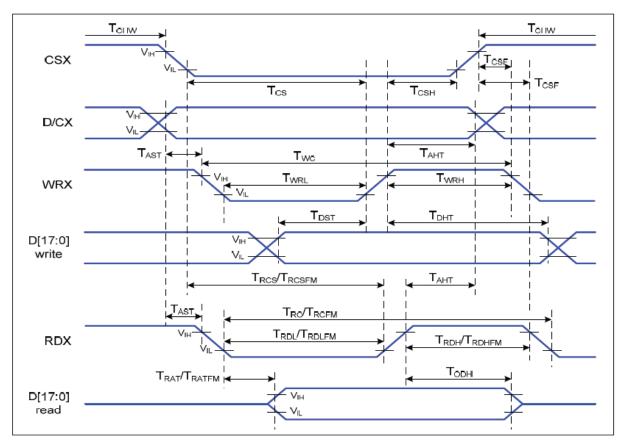


Fig. 8.1.1 Parallel interface ti	timing characteristics	(8080 series MCU interface)

Signal	Symbol	Parameter		Max	Unit	Description
D/CX	TAST	Address setup time	10		ns	
DICX	TAHT	Address hold time (Write/Read)	10		ns	-
	TCHW	Chip select "H" pulse width	0		ns	
	TCS	Chip select setup time (Write)	15		ns	
csx	TRCS	Chip select setup time (Read ID)	45		ns	
037	TRCSFM	Chip select setup time (Read FM)	350		ns	-
	TCSF	Chip select wait time (Write/Read)			ns	
	TCSH	Chip select hold time	10		ns	

	TWC	Write cycle	100		ns	
WRX	TWRH	Control pulse "H" duration			ns	
	TWRL	Control pulse "L" duration	30		ns	
	TRC	Read cycle (ID)	160		ns	
RDX (ID)	TRDH	Control pulse "H" duration (ID)	90		ns	When read ID data
	TRDL	Control pulse "L" duration (ID)			ns	
RDX	TRCFM	Read cycle (FM)	450		ns	When read from frame
(FM)	TRDHFM	1 Control pulse "H" duration (FM)			ns	memory
	TRDLFM	Control pulse "L" duration (FM)	150		ns	memory
	TDST	Data setup time	10		ns	
	TDHT	Data hold time	10		ns	1
D[17:0]	TRAT	Read access time (ID)		40	ns	For CL=30pF
	TRATFM	/ Read access time (FM)		40	ns	
	TODH	Output disable time		80	ns	

Table 8.1.1 Parallel Interface Characteristics

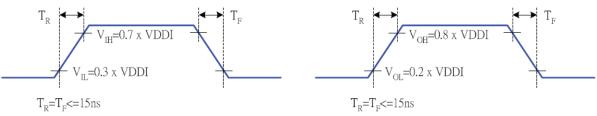


Fig. 8.1.2 Rising and falling timing for input and output signal

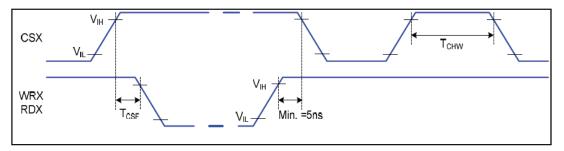


Fig. 8.1.3 Chip selection (CSX) timing

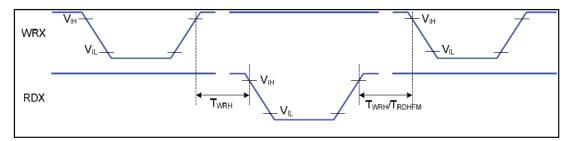


Fig. 8.1.4 Write-to-read and read-to-write timing

Note: The rising time and falling time (Tr, Tf) of input signal are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

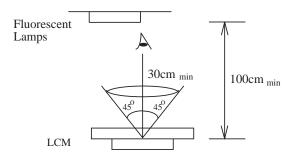
### **<u>11.Quality Specifications</u>**

### All The raw material are Rohs complicant.

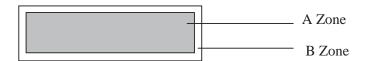
### 11.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: viewing area B Zone: outside viewing area

### **11.2 Specification of quality assurance**

AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

Classify		Item	Note	AQL
Major	Display state	Short or open circuit		0.65
		LC leakage		
		Flickering	1	
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display state	Background color deviation	2	1.0
		Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
	Polarizer	Protruded	12	
		Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	

**Defect classification (Note: \* is not including)** 

### Note on defect classification

No.	Item			Criterion		
1	Short or open circuit			Not allow		
	LC leakage					
	Flickering	•				
	No display	•				
	Wrong viewing direction					
	Wrong Back-light					
2	Contrast defect		Refe	to approval sa	mple	
	Background color deviation					
3	Point defect, Black spot, dust (including Polarizer)	<b>∏</b> <b>X</b>		Point Size ¢≤0.10	Acceptable Qty.	
			-	<u>¢≤</u> 0.10 0.10<¢≤0.20		
			_	0.20<∳≤0.25		
	$\phi = (X+Y)/2$		_	0.25<∳≤0.30	1	
				φ>0.30	0	
			Unit	: mm		
4	Line defect,					
	Scratch			Line	Acceptable Qty.	
	Seraten	I I I	L	W 0.015≥W	Disregard	-
		L	3.0≥			
			2.0≥	L 0.05≥W	2	
			1.0≥		1	_
				0.05 <w< td=""><td>Applied as point defect</td><td>  [_</td></w<>	Applied as point defect	[_
		Unit: mm				
5	Rainbow	Not more than two color changes across the viewing area.				

No	Item	Criterion
6	Chip Remark: X: Length direction Y: Short	$X \qquad Y \qquad Acceptable criterion$ $X \qquad Y \qquad Z \qquad \forall T \qquad T \qquad X \qquad Y \qquad Z \qquad \forall T \qquad X \qquad Y \qquad Z \qquad \forall T \qquad X \qquad Y \qquad Z \qquad \forall T \qquad X \qquad Y \qquad Z \qquad \forall T \qquad T \qquad \forall T \qquad T \qquad T \qquad T \qquad T \qquad T \qquad T$
	<ul> <li>T. Short direction</li> <li>Z: Thickness direction</li> <li>t: Glass thickness</li> <li>W: Terminal Width</li> </ul>	$\begin{array}{c c} X & Y \\ \hline \\ X & Y \\ \hline \\ Z \\ \end{array} \begin{array}{c} X & Y \\ \hline \\ \hline \\ Z \\ \end{array} \begin{array}{c} X & Y \\ \hline \\ \hline \\ \hline \\ Z \\ \end{array} \begin{array}{c} Acceptable \ criterion \\ \hline \\ \hline \\ \hline \\ \hline \\ \hline \\ \hline \\ Z \\ \end{array} \begin{array}{c} X & Y \\ \hline \\ \hline \\ \hline \\ \hline \\ \hline \\ \hline \\ Z \\ \end{array} \begin{array}{c} X & Y \\ \hline \\$
		$\begin{array}{c c} & Acceptable criterion \\ \hline X & Y & Z \\ \hline \leqslant 3 & \leqslant 2 & \leqslant t \\ \hline shall not reach to ITO \\ \hline \end{array}$
		$\begin{array}{c c} W_{\underline{y}} \\ \hline W_{\underline{y}} $
		$\begin{array}{c c} & Y \\ & & \\ \hline & & \\ & \\ & \\ & \\ & \\ & \\ & \\$

No.	Item	Criterion					
7	Segment pattern W = Segment width $\phi = (X+Y)/2$	(1) Pin hole $\phi < 0.10$ mm is acceptable. X Point Size Acceptable Qty					
		$\begin{array}{c c} Y & \swarrow &$					
8	Back-light	<ol> <li>The color of backlight should correspond its specification.</li> <li>Not allow flickering</li> </ol>					
9	Soldering	<ul> <li>(2) Not allow mckening</li> <li>(1) Not allow heavy dirty and solder ball on PCB.</li> <li>(The size of dirty refer to point and dust defect)</li> <li>(2) Over 50% of lead should be soldered on Land.</li> </ul>					
10	Wire	<ul> <li>(1) Copper wire should not be rusted</li> <li>(2) Not allow crack on copper wire connection.</li> <li>(3) Not allow reversing the position of the flat cable.</li> <li>(4) Not allow exposed copper wire inside the flat cable.</li> </ul>					
11*	РСВ	<ul><li>(1) Not allow screw rust or damage.</li><li>(2) Not allow missing or wrong putting of component.</li></ul>					

No	Item	Criterion
12	Protruded W: Terminal Width	$W_{\underline{N}}$ Acceptable criteria: $Y \le 0.4$
13	ТАВ	1. Position H $H$
14	Total no. of acceptable Defect	<ul> <li>A. Zone</li> <li>Maximum 2 minor non-conformities per one unit.</li> <li>Defect distance: each point to be separated over 10mm</li> <li>B. Zone</li> <li>It is acceptable when it is no trouble for quality and assembly in customer's end product.</li> </ul>

### 11.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	60°C	48	
High temp. Operating	50°C	48	
Low temp. Storage	-10°C	48	No abnormalities
Low temp. Operating	0°C	48	in functions
Humidity	40°C/90%RH	48	and appearance
Temp. Cycle	$-10^{\circ}C \leftarrow 25^{\circ}C \rightarrow 60^{\circ}C$	10cycles	
	$(60 \min \leftarrow 5 \min \rightarrow 60 \min)$		

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ( $20\pm8^{\circ}C$ ), normal humidity (below 65% RH), and in the area not exposed to direct sun light.

### 11.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

### **General Precautions:**

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not made any modification on the PCB without consulting Regal Honour.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

### **Static Electricity Precautions:**

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

### **Soldering Precautions:**

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature:  $280^{\circ}C \pm 10^{\circ}C$
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

### **Operation Precautions:**

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

### **Limited Warranty**

Regal Honour LCDs and modules are not consumer products, but may be incorporated by Regal Honour's customers into consumer products or components thereof, Regal Honour does not warrant that its LCDs and components are fit for any such particular purpose.

- 1. The liability of Regal Honour is limited to repair or replacement on the terms set forth below. Regal Honour will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between Regal Honour and the customer, Regal Honour will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with Regal Honour general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.